



## General Description

The SJD010N850 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

## Features

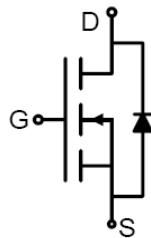
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

## Application

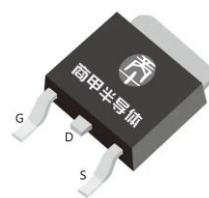
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

## Key Performance Parameters

Parameter	Value	Unit
$V_{DS}$	100	V
$R_{DS(ON)}_{TYP}$	77.8	$m\Omega$
$I_D$	13	A
$Q_G$	20.2	nC



Schematic Diagram



TO-252(DPAK) top view

## Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJD010N850	D010N850	TO-252	Tape	\	\	2500 Pcs

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ C$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	100	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_c=25^\circ C$ )	13	A
	Drain Current-Continuous( $T_c=100^\circ C$ )	8.3	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	52	A
$P_D$	Maximum Power Dissipation( $T_c=25^\circ C$ )	30	W
	Maximum Power Dissipation( $T_c=100^\circ C$ )	12	W
$E_{AS}$	Avalanche energy (Note 2)	25	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{eJC}$	Thermal Resistance, Junction-to-Case		4.2	°C/W



## 100V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	100			V
$I_{\text{DS}(\text{SS})}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=100\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	$\mu\text{A}$
		$V_{\text{DS}}=100\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	1		2.5	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=2\text{A}$		6		S
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=2\text{A}$ $T_J=25^\circ\text{C}$		77.8	94	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=2\text{A}$ $T_J=25^\circ\text{C}$		81.4	120	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=50\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		951		pF
$C_{\text{oss}}$	Output Capacitance			32.3		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			27.3		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		1.3		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=50\text{V}$ , $R_L=5\Omega$ , $R_{\text{GEN}}=3\Omega$		6.6		nS
$t_r$	Turn-on Rise Time			46		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			31		nS
$t_f$	Turn-Off Fall Time			4		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=50\text{V}$ , $I_{\text{D}}=2\text{A}$		20.2		nC
$Q_{\text{gs}}$	Gate-Source Charge			2.1		nC
$Q_{\text{gd}}$	Gate-Drain Charge			4.2		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				13	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=2\text{A}$			1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		26		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		35		nC

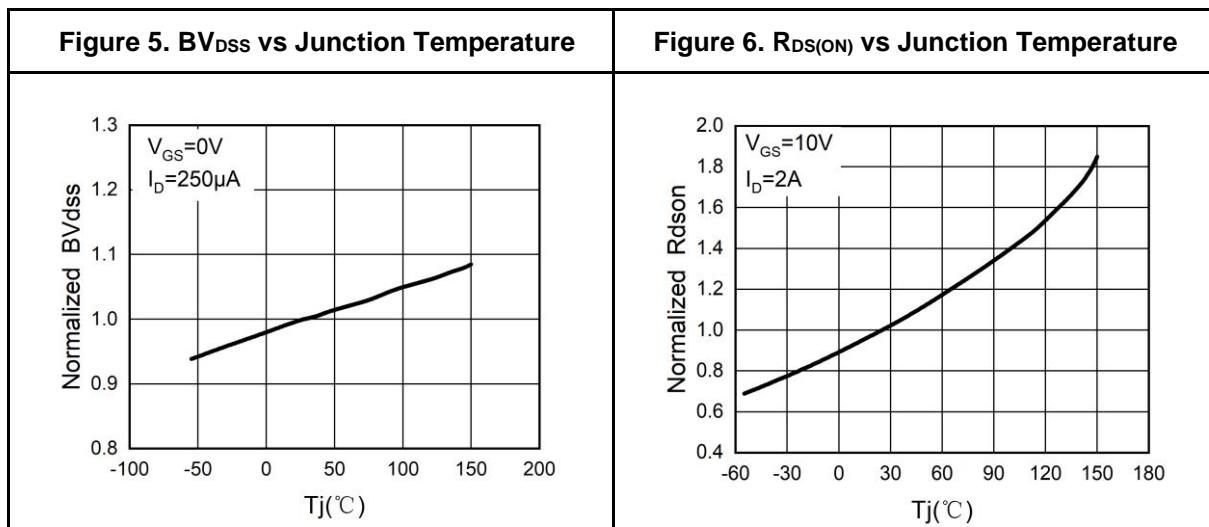
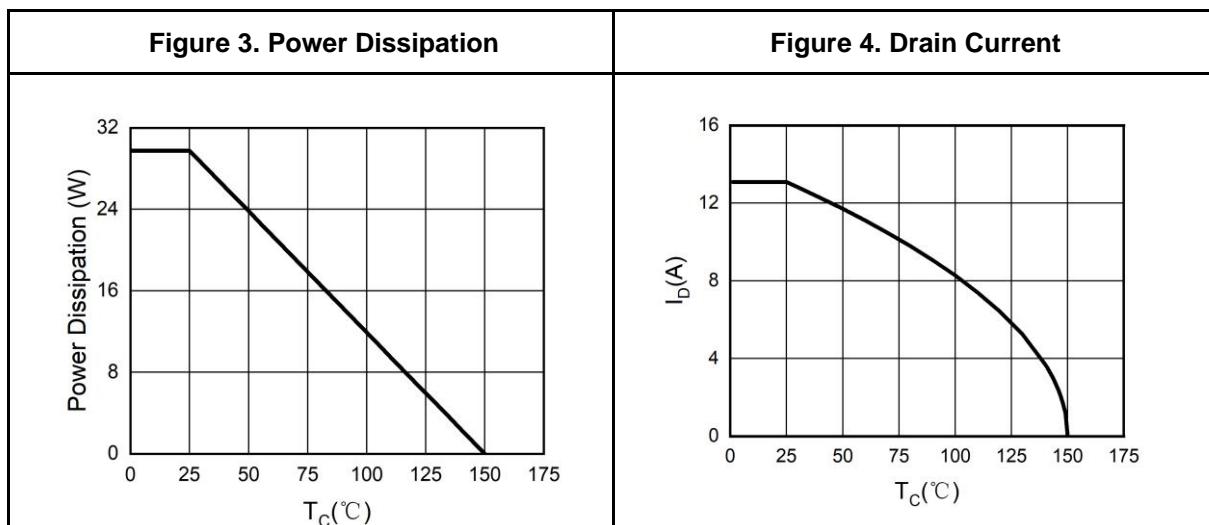
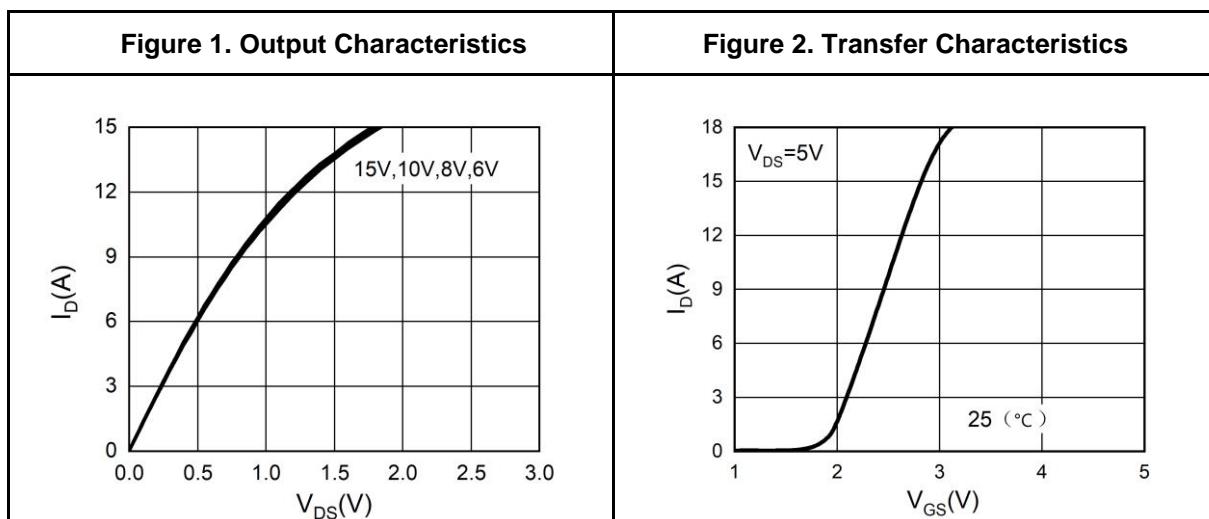
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=40\text{V}$ ,  $V_G=10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

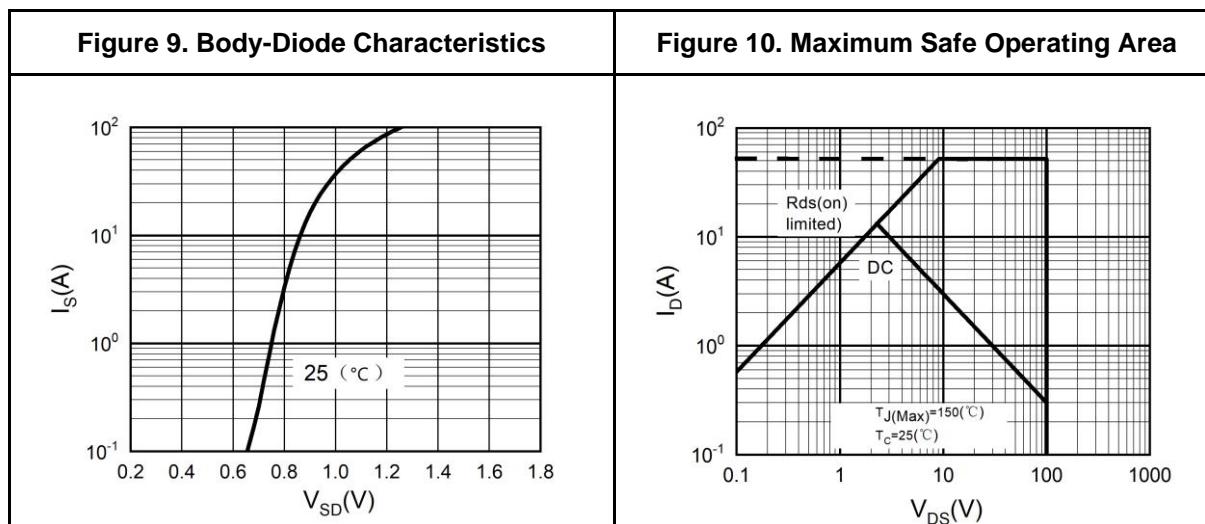
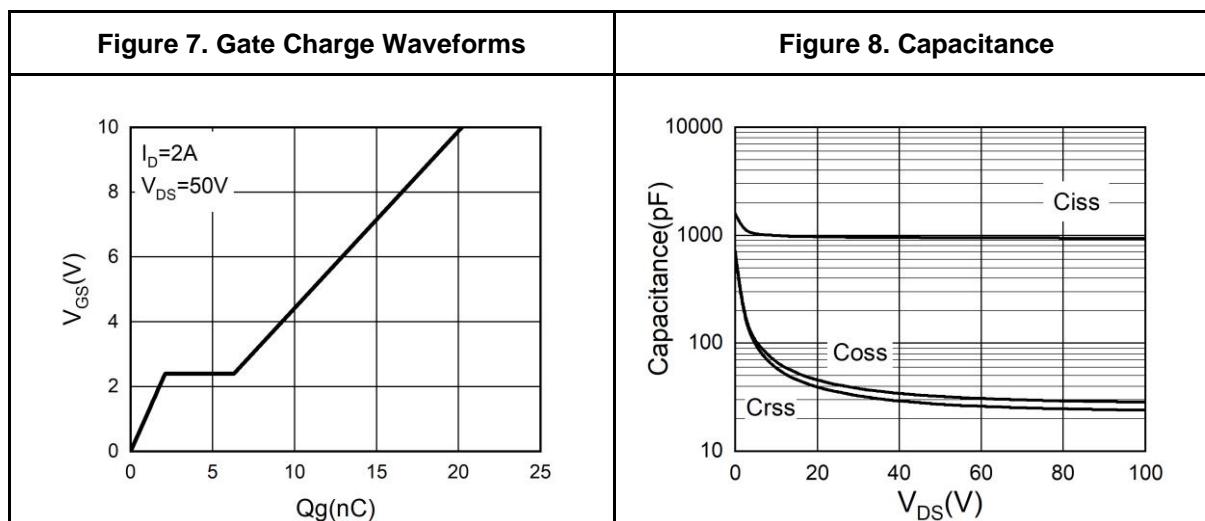


## Typical Electrical And Thermal Characteristics (Curves)



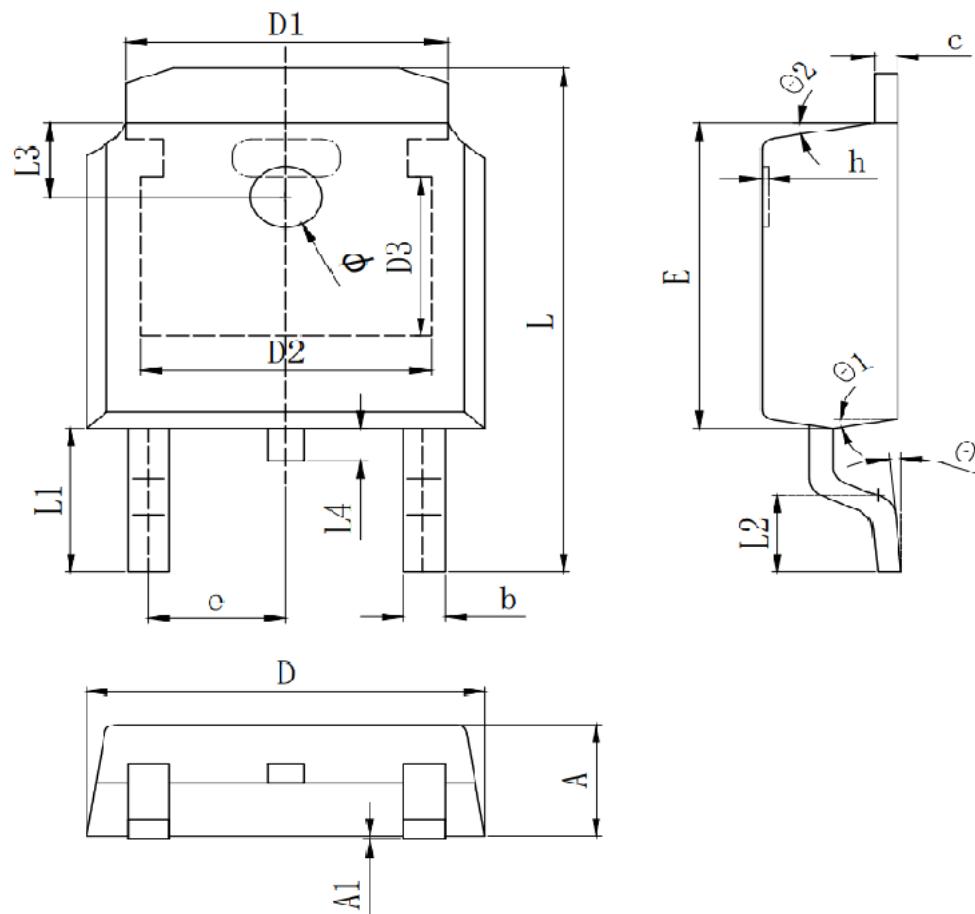


## Typical Electrical And Thermal Characteristics (Curves)





## TO-252 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1		5.334 REF	
D2		4.826 REF	
D3		3.166 REF	
E	6.000	6.100	6.200
e		2.286 TYP	
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1		2.888 REF	
L2	1.400	1.550	1.700
L3		1.600 REF	
L4	0.600	0.800	1.000
Φ	1.100	1.200	1.300
θ	0°		8°
θ1		9° TYP	
θ2		9° TYP	



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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